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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	18
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f690-i-so

2.2 Data Memory Organization

The data memory (see Figures 2-6 through 2-8) is partitioned into four banks which contain the General Purpose Registers (GPR) and the Special Function Registers (SFR). The Special Function Registers are located in the first 32 locations of each bank. The General Purpose Registers, implemented as static RAM, are located in the last 96 locations of each Bank. Register locations F0h-FFh in Bank 1, 170h-17Fh in Bank 2 and 1F0h-1FFh in Bank 3 point to addresses 70h-7Fh in Bank 0. The actual number of General Purpose Registers (GPR) in each Bank depends on the device. Details are shown in Figures 2-4 through 2-8. All other RAM is unimplemented and returns '0' when read. RP<1:0> of the STATUS register are the bank select bits:

<u>RP1</u>	<u>RP0</u>	
0	0	→ Bank 0 is selected
0	1	→ Bank 1 is selected
1	0	→ Bank 2 is selected
1	1	→ Bank 3 is selected

2.2.1 GENERAL PURPOSE REGISTER FILE

The register file is organized as 128 x 8 in the PIC16F687 and 256 x 8 in the PIC16F685/PIC16F689/PIC16F690. Each register is accessed, either directly or indirectly, through the File Select Register (FSR) (see **Section 2.4 “Indirect Addressing, INDF and FSR Registers”**).

2.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral functions for controlling the desired operation of the device (see Tables 2-1 through 2-4). These registers are static RAM.

The special registers can be classified into two sets: core and peripheral. The Special Function Registers associated with the “core” are described in this section. Registers related to the operation of peripheral features are described in the section of that peripheral feature.

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FIGURE 2-8: PIC16F690 SPECIAL FUNCTION REGISTERS

File Address	File Address	File Address	File Address
Indirect addr. ⁽¹⁾ 00h	Indirect addr. ⁽¹⁾ 80h	Indirect addr. ⁽¹⁾ 100h	Indirect addr. ⁽¹⁾ 180h
TMR0 01h	OPTION_REG 81h	TMR0 101h	OPTION_REG 181h
PCL 02h	PCL 82h	PCL 102h	PCL 182h
STATUS 03h	STATUS 83h	STATUS 103h	STATUS 183h
FSR 04h	FSR 84h	FSR 104h	FSR 184h
PORTA 05h	TRISA 85h	PORTA 105h	TRISA 185h
PORTB 06h	TRISB 86h	PORTB 106h	TRISB 186h
PORTC 07h	TRISC 87h	PORTC 107h	TRISC 187h
08h	88h	108h	188h
09h	89h	109h	189h
PCLATH 0Ah	PCLATH 8Ah	PCLATH 10Ah	PCLATH 18Ah
INTCON 0Bh	INTCON 8Bh	INTCON 10Bh	INTCON 18Bh
PIR1 0Ch	PIE1 8Ch	EEDAT 10Ch	EECON1 18Ch
PIR2 0Dh	PIE2 8Dh	EEADR 10Dh	EECON2 ⁽⁴⁾ 18Dh
TMR1L 0Eh	PCON 8Eh	EEDATH 10Eh	18Eh
TMR1H 0Fh	OSCCON 8Fh	EEADRH 10Fh	18Fh
T1CON 10h	OSCTUNE 90h	110h	190h
TMR2 11h	91h	111h	191h
T2CON 12h	PR2 92h	112h	192h
SSPBUF 13h	SSPADD ⁽²⁾ 93h	113h	193h
SSPCON 14h	SSPSTAT 94h	114h	194h
CCPR1L 15h	WPUA 95h	WPUB 115h	195h
CCPR1H 16h	IOCA 96h	IOCB 116h	196h
CCP1CON 17h	WDTCON 97h	117h	197h
RCSTA 18h	TXSTA 98h	VRCON 118h	198h
TXREG 19h	SPBRG 99h	CM1CON0 119h	199h
RCREG 1Ah	SPBRGH 9Ah	CM2CON0 11Ah	19Ah
1Bh	BAUDCTL 9Bh	CM2CON1 11Bh	19Bh
PWM1CON 1Ch	9Ch	11Ch	19Ch
ECCPAS 1Dh	9Dh	11Dh	PSTRCON 19Dh
ADRESH 1Eh	ADRESL 9Eh	ANSEL 11Eh	SRCN 19Eh
ADCON0 1Fh	ADCON1 9Fh	ANSELH 11Fh	19Fh
20h	A0h	120h	1A0h
General Purpose Register	General Purpose Register	General Purpose Register	
96 Bytes	80 Bytes	80 Bytes	
7Fh	EFh	16Fh	
	accesses F0h	accesses 170h	accesses 1F0h
	70h-7Fh FFh	70h-7Fh 17Fh	70h-7Fh 1FFh
Bank 0	Bank 1	Bank 2	Bank 3

☐ Unimplemented data memory locations, read as '0'.

Note 1: Not a physical register.
2: Address 93h also accesses the SSP Mask (SSPMSK) register under certain conditions. See Registers 13-2 and 13-3 for more details.

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3.2 Oscillator Control

The Oscillator Control (OSCCON) register (Figure 3-1) controls the system clock and frequency selection options. The OSCCON register contains the following bits:

- Frequency selection bits (IRCF)
- Frequency Status bits (HTS, LTS)
- System clock control bits (OSTS, SCS)

REGISTER 3-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	R/W-1	R/W-1	R/W-0	R-1	R-0	R-0	R/W-0
—	IRCF2	IRCF1	IRCF0	OSTS ⁽¹⁾	HTS	LTS	SCS
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **IRCF<2:0>:** Internal Oscillator Frequency Select bits

111 = 8 MHz

110 = 4 MHz (default)

101 = 2 MHz

100 = 1 MHz

011 = 500 kHz

010 = 250 kHz

001 = 125 kHz

000 = 31 kHz (LFINTOSC)

bit 3 **OSTS:** Oscillator Start-up Time-out Status bit⁽¹⁾

1 = Device is running from the clock defined by FOSC<2:0> of the CONFIG register

0 = Device is running from the internal oscillator (HFINTOSC or LFINTOSC)

bit 2 **HTS:** HFINTOSC Status bit (High Frequency – 8 MHz to 125 kHz)

1 = HFINTOSC is stable

0 = HFINTOSC is not stable

bit 1 **LTS:** LFINTOSC Stable bit (Low Frequency – 31 kHz)

1 = LFINTOSC is stable

0 = LFINTOSC is not stable

bit 0 **SCS:** System Clock Select bit

1 = Internal oscillator is used for system clock

0 = Clock source defined by FOSC<2:0> of the CONFIG register

Note 1: Bit resets to '0' with Two-Speed Start-up and LP, XT or HS selected as the Oscillator mode or Fail-Safe mode is enabled.

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4.5.1 RC0/AN4/C2IN+

The RC0 is configurable to function as one of the following:

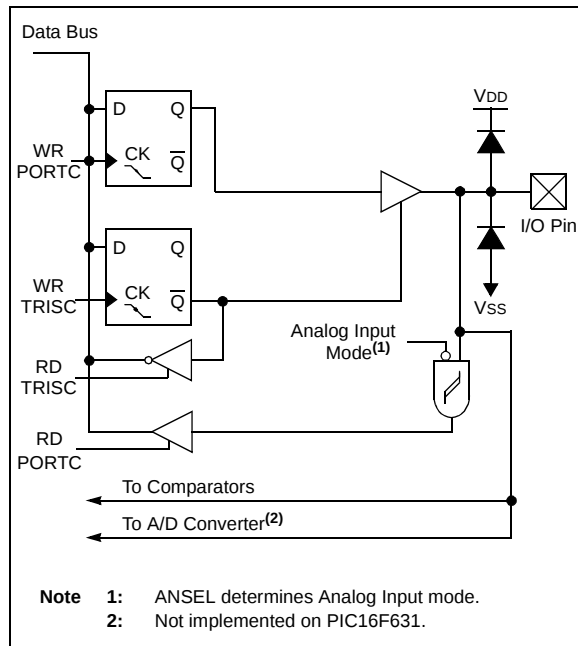
- a general purpose I/O
- an analog input for the ADC (except PIC16F631)
- an analog input to Comparator C2

4.5.2 RC1/AN5/C12IN1-

The RC1 is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC
- an analog input to Comparator C1 or C2

FIGURE 4-11: BLOCK DIAGRAM OF RC0 AND RC1



4.5.3 RC2/AN6/C12IN2-/P1D

The RC2/AN6/P1D⁽¹⁾ is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC (except PIC16F631)
- a PWM output
- an analog input to Comparator C1 or C2

Note 1: P1D is available on PIC16F685/PIC16F690 only.

4.5.4 RC3/AN7/C12IN3-/P1C

The RC3/AN7/P1C⁽¹⁾ is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC (except PIC16F631)
- a PWM output
- a PWM output
- an analog input to Comparator C1 or C2

Note 1: P1C is available on PIC16F685/PIC16F690 only.

FIGURE 4-12: BLOCK DIAGRAM OF RC2 AND RC3

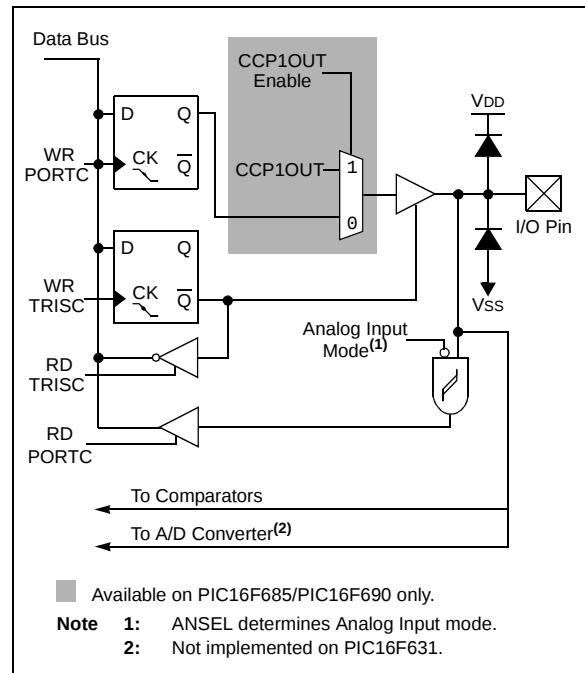
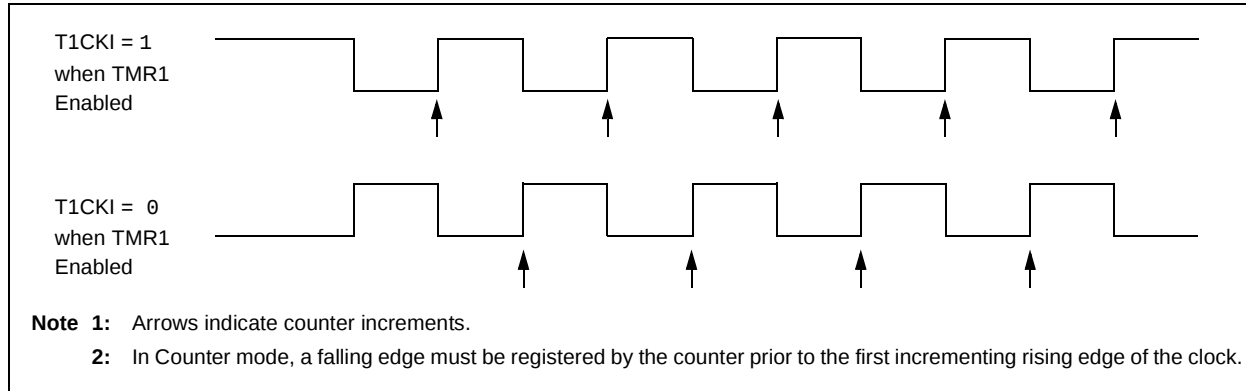


FIGURE 6-2: TIMER1 INCREMENTING EDGE



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REGISTER 7-1: T2CON: TIMER 2 CONTROL REGISTER⁽¹⁾

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-3 **TOUTPS<3:0>:** Timer2 Output Postscaler Select bits

0000 =1:1 Postscaler

0001 =1:2 Postscaler

0010 =1:3 Postscaler

0011 =1:4 Postscaler

0100 =1:5 Postscaler

0101 =1:6 Postscaler

0110 =1:7 Postscaler

0111 =1:8 Postscaler

1000 =1:9 Postscaler

1001 =1:10 Postscaler

1010 =1:11 Postscaler

1011 =1:12 Postscaler

1100 =1:13 Postscaler

1101 =1:14 Postscaler

1110 =1:15 Postscaler

1111 =1:16 Postscaler

bit 2 **TMR2ON:** Timer2 On bit

1 = Timer2 is on

0 = Timer2 is off

bit 1-0 **T2CKPS<1:0>:** Timer2 Clock Prescale Select bits

00 =Prescaler is 1

01 =Prescaler is 4

1x =Prescaler is 16

Note 1: PIC16F685/PIC16F690 only.

TABLE 7-1: SUMMARY OF ASSOCIATED TIMER2⁽¹⁾ REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
INTCON	GIE	PEIE	T0IE	INTE	RABIE	T0IF	INTF	RABIF	0000 000x	0000 000x
PIE1	—	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
PIR1	—	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PR2	Timer2 Module Period Register								1111 1111	1111 1111
TMR2	Holding Register for the 8-bit TMR2 Register								0000 0000	0000 0000
T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000

Legend: x = unknown, u = unchanged, — = unimplemented read as '0'. Shaded cells are not used for Timer2 module.

Note 1: PIC16F685/PIC16F690 only.

8.2 Comparator Control

Each comparator has a separate control and Configuration register: CM1CON0 for Comparator C1 and CM2CON0 for Comparator C2. In addition, Comparator C2 has a second control register, CM2CON1, for controlling the interaction with Timer1 and simultaneous reading of both comparator outputs.

The CM1CON0 and CM2CON0 registers (see Registers 8-1 and 8-2, respectively) contain the control and Status bits for the following:

- Enable
- Input selection
- Reference selection
- Output selection
- Output polarity

8.2.1 COMPARATOR ENABLE

Setting the CxON bit of the CMxCON0 register enables the comparator for operation. Clearing the CxON bit disables the comparator resulting in minimum current consumption.

8.2.2 COMPARATOR INPUT SELECTION

The CxCH<1:0> bits of the CMxCON0 register direct one of four analog input pins to the comparator inverting input.

Note: To use CxIN+ and C12INx- pins as analog inputs, the appropriate bits must be set in the ANSEL register and the corresponding TRIS bits must also be set to disable the output drivers.

8.2.3 COMPARATOR REFERENCE SELECTION

Setting the CxR bit of the CMxCON0 register directs an internal voltage reference or an analog input pin to the non-inverting input of the comparator. See **Section 8.9 “Comparator SR Latch”** for more information on the Internal Voltage Reference module.

8.2.4 COMPARATOR OUTPUT SELECTION

The output of the comparator can be monitored by reading either the CxOUT bit of the CMxCON0 register or the MCxOUT bit of the CM2CON1 register. In order to make the output available for an external connection, the following conditions must be true:

- CxOE bit of the CMxCON0 register must be set
- Corresponding TRIS bit must be cleared
- CxON bit of the CMxCON0 register must be set

Note 1: The CxOE bit overrides the PORT data latch. Setting the CxON has no impact on the port override.

2: The internal output of the comparator is latched with each instruction cycle. Unless otherwise specified, external outputs are not latched.

8.2.5 COMPARATOR OUTPUT POLARITY

Inverting the output of the comparator is functionally equivalent to swapping the comparator inputs. The polarity of the comparator output can be inverted by setting the CxPOL bit of the CMxCON0 register. Clearing the CxPOL bit results in a non-inverted output.

Table 8-1 shows the output state versus input conditions, including polarity control.

TABLE 8-1: COMPARATOR OUTPUT STATE VS. INPUT CONDITIONS

Input Condition	CxPOL	CxOUT
CxVIN- > CxVIN+	0	0
CxVIN- < CxVIN+	0	1
CxVIN- > CxVIN+	1	1
CxVIN- < CxVIN+	1	0

8.3 Comparator Response Time

The comparator output is indeterminate for a period of time after the change of an input source or the selection of a new reference voltage. This period is referred to as the response time. The response time of the comparator differs from the settling time of the voltage reference. Therefore, both of these times must be considered when determining the total response time to a comparator input change. See the Comparator and Voltage Reference Specifications in **Section 17.0 “Electrical Specifications”** for more details.

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REGISTER 8-5: VRCON: VOLTAGE REFERENCE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
C1VREN	C2VREN	VRR	VP6EN	VR3	VR2	VR1	VR0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- bit 7 **C1VREN:** Comparator 1 Voltage Reference Enable bit
 1 = CVREF circuit powered on and routed to C1VREF input of Comparator C1
 0 = 0.6 Volt constant reference routed to C1VREF input of Comparator C1
- bit 6 **C2VREN:** Comparator 2 Voltage Reference Enable bit
 1 = CVREF circuit powered on and routed to C2VREF input of Comparator C2
 0 = 0.6 Volt constant reference routed to C2VREF input of Comparator C2
- bit 5 **VRR:** CVREF Range Selection bit
 1 = Low range
 0 = High range
- bit 4 **VP6EN:** 0.6V Reference Enable bit
 1 = Enabled
 0 = Disabled
- bit 3-0 **VR<3:0>:** Comparator Voltage Reference CVREF Value Selection bits ($0 \leq VR<3:0> \leq 15$)
 When VRR = 1: CVREF = (VR<3:0>/24) * VDD
 When VRR = 0: CVREF = VDD/4 + (VR<3:0>/32) * VDD

TABLE 8-2: SUMMARY OF REGISTERS ASSOCIATED WITH THE COMPARATOR AND VOLTAGE REFERENCE MODULES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
ANSEL	ANS7	ANS6	ANS5	ANS4	ANS3	ANS2	ANS1	ANS0	1111 1111	1111 1111
CM1CON0	C1ON	C1OUT	C1OE	C1POL	—	C1R	C1CH1	C1CH0	0000 -000	0000 0000
CM2CON0	C2ON	C2OUT	C2OE	C2POL	—	C2R	C2CH1	C2CH0	0000 -000	0000 -000
CM2CON1	MC1OUT	MC2OUT	—	—	—	—	T1GSS	C2SYNC	00-- --10	00-- --10
INTCON	GIE	PEIE	T0IE	INTE	RABIE	T0IF	INTF	RABIF	0000 000x	0000 000x
PIE2	OSFIE	C2IE	C1IE	EEIE	—	—	—	—	0000 ----	0000 ----
PIR2	OSFIF	C2IF	C1IF	EEIF	—	—	—	—	0000 ----	0000 ----
PORTA	—	—	RA5	RA4	RA3	RA2	RA1	RA0	--xx xxxx	--uu uuuu
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
SRCON	SR1	SR0	C1SEN	C2REN	PULSS	PULSR	—	—	0000 00--	0000 00--
TRISA	—	—	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	--11 1111	--11 1111
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111	1111 1111
VRCON	C1VREN	C2VREN	VRR	VP6EN	VR3	VR2	VR1	VR0	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, – = unimplemented, read as '0'. Shaded cells are not used for comparator.

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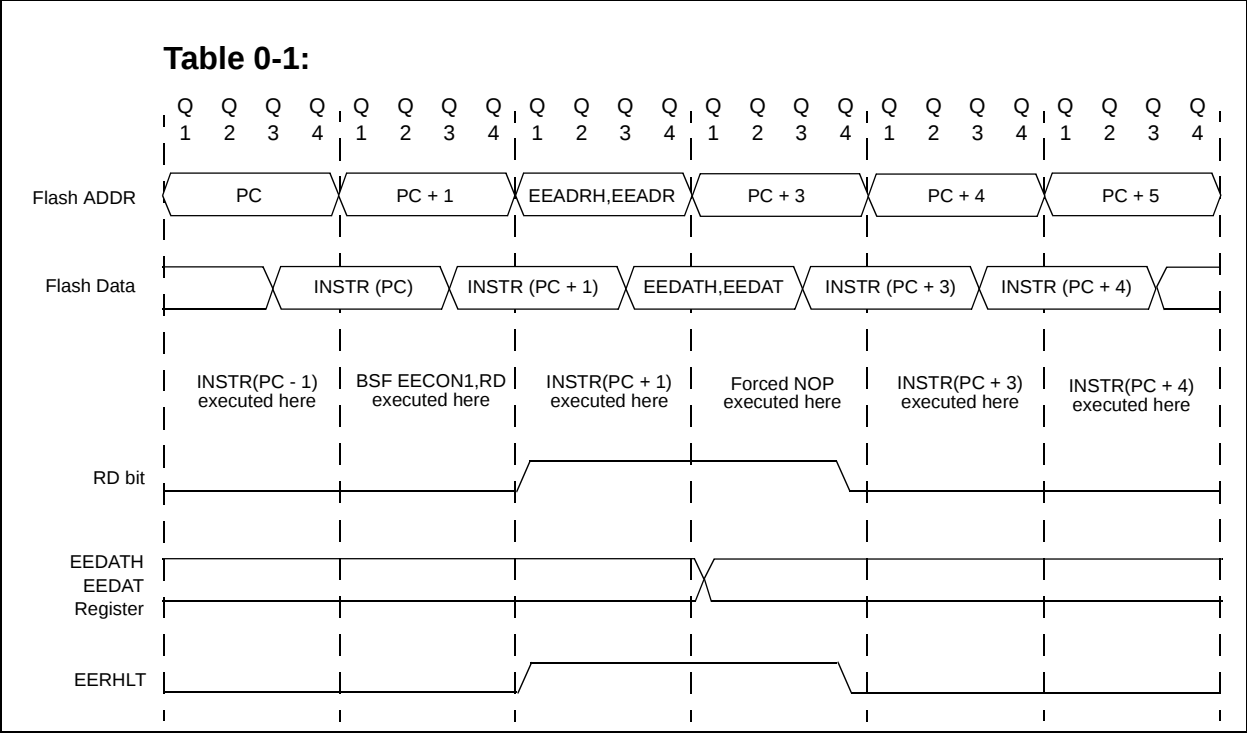
TABLE 9-2: SUMMARY OF ASSOCIATED ADC REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
ADCON0	ADFM	VCFG	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	0000 0000	0000 0000
ADCON1	—	ADCS2	ADCS1	ADCS0	—	—	—	—	-000 ----	-000 ----
ANSEL	ANS7	ANS6	ANS5	ANS4	ANS3	ANS2	ANS1	ANS0	1111 1111	1111 1111
ANSELH	—	—	—	—	ANS11	ANS10	ANS9	ANS8	---- 1111	---- 1111
ADRESH	A/D Result Register High Byte								xxxx xxxx	uuuu uuuu
ADRESL	A/D Result Register Low Byte								xxxx xxxx	uuuu uuuu
INTCON	GIE	PEIE	T0IE	INTE	RABIE	T0IF	INTF	RABIF	0000 000x	0000 000x
PIE1	—	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	-000 0000	-000 0000
PIR1	—	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	-000 0000	-000 0000
PORTA	—	—	RA5	RA4	RA3	RA2	RA1	RA0	--xx xxxx	--uu uuuu
PORTB	RB7	RB6	RB5	RB4	—	—	—	—	xxxx ----	uuuu ----
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
TRISA	—	—	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	--11 1111	--11 1111
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	—	—	—	—	1111 ----	1111 ----
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged, — = unimplemented read as '0'. Shaded cells are not used for ADC module.

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FIGURE 10-1: FLASH PROGRAM MEMORY READ CYCLE EXECUTION



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13.2 Operation

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPCON<5:0> and SSPSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- Slave mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

The SSP consists of a transmit/receive shift register (SSPSR) and a buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR until the received data is ready. Once the eight bits of data have been received, that byte is moved to the SSPBUF register. Then, the Buffer Full Status bit BF of the SSPSTAT register, and the interrupt flag bit SSPIF, are set. This double-buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored and the Write Collision Detect bit, WCOL of the SSPCON register, will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. Buffer Full bit BF of the SSPSTAT register indicates when SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the SSP interrupt is used to determine when the transmission/reception has completed. The SSPBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 13-1 shows the loading of the SSPBUF (SSPSR) for data transmission.

The SSPSR is not directly readable or writable and can only be accessed by addressing the SSPBUF register. Additionally, the SSP Status register (SSPSTAT) indicates the various status conditions.

EXAMPLE 13-1: LOADING THE SSPBUF (SSPSR) REGISTER

	BSF	STATUS, RP0	;Bank 1
	BCF	STATUS, RP1	;
LOOP	BTFSS	SSPSTAT, BF	;Has data been received(transmit complete)?
	GOTO	LOOP	;No
	BCF	STATUS, RP0	;Bank 0
	MOVF	SSPBUF, W	;WREG reg = contents of SSPBUF
	MOVWF	RXDATA	;Save in user RAM, if data is meaningful
	MOVF	TXDATA, W	;W reg = contents of TXDATA
	MOVWF	SSPBUF	;New data to xmit

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13.12.1 ADDRESSING

Once the SSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the eight bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- The SSPSR register value is loaded into the SSPBUF register.
- The buffer full bit, BF is set.
- An $\overline{\text{ACK}}$ pulse is generated.
- SSP interrupt flag bit, SSPIF of the PIR1 register is set (interrupt is generated if enabled) on the falling edge of the ninth SCL pulse.

In 10-bit Address mode, two address bytes need to be received by the slave (Figure 13-8). The five Most Significant bits (MSBs) of the first address byte specify if this is a 10-bit address. Bit R/W (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSBs of the address.

The sequence of events for 10-bit address is as follows, with steps 7-9 for slave-transmitter:

- Receive first (high) byte of address (bits SSPIF, BF and bit UA (SSPSTAT<1>) are set).
- Update the SSPADD register with second (low) byte of address (clears bit UA and releases the SCL line).
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- Receive second (low) byte of address (bits SSPIF, BF and UA are set).
- Update the SSPADD register with the first (high) byte of address; if match releases SCL line, this will clear bit UA.
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- Receive repeated Start condition.
- Receive first (high) byte of address (bits SSPIF and BF are set).
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

TABLE 13-3: DATA TRANSFER RECEIVED BYTE ACTIONS

Status Bits as Data Transfer is Received		SSPSR → SSPBUF	Generate $\overline{\text{ACK}}$ Pulse	Set bit SSPIF (SSP Interrupt occurs if enabled)
BF	SSPOV			
0	0	Yes	Yes	Yes
1	0	No	No	Yes
1	1	No	No	Yes
0	1	No	No	Yes

Note: Shaded cells show the conditions where the user software did not properly clear the overflow condition.

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14.4 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt (e.g., W and STATUS registers). This must be implemented in software.

Since the upper 16 bytes of all GPR banks are common in the PIC16F631/677/685/687/689/690 (see Figures 2-2 and 2-3), temporary holding registers, W_TEMP and STATUS_TEMP, should be placed in here. These 16 locations do not require banking and therefore, make it easier to context save and restore. The same code shown in Example 14-1 can be used to:

- Store the W register
- Store the STATUS register
- Execute the ISR code
- Restore the Status (and Bank Select Bit register)
- Restore the W register

Note: The PIC16F631/677/685/687/689/690 normally does not require saving the PCLATH. However, if computed GOTO's are used in the ISR and the main code, the PCLATH must be saved and restored in the ISR.

EXAMPLE 14-1: SAVING STATUS AND W REGISTERS IN RAM

MOVWF W_TEMP	;Copy W to TEMP register
SWAPF STATUS,W	;Swap status to be saved into W
CLRF STATUS	;bank 0, regardless of current bank, Clears IRP,RP1,RP0
MOVWF STATUS_TEMP	;Save status to bank zero STATUS_TEMP register
:	
:(ISR)	;Insert user code here
:	
SWAPF STATUS_TEMP,W	;Swap STATUS_TEMP register into W
	;(sets bank to original state)
MOVWF STATUS	;Move W into STATUS register
SWAPF W_TEMP,F	;Swap W_TEMP
SWAPF W_TEMP,W	;Swap W_TEMP into W

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14.5 Watchdog Timer (WDT)

The WDT has the following features:

- Operates from the LFINTOSC (31 kHz)
- Contains a 16-bit prescaler
- Shares an 8-bit prescaler with Timer0
- Time-out period is from 1 ms to 268 seconds
- Configuration bit and software controlled

WDT is cleared under certain conditions described in Table 14-7.

14.5.1 WDT OSCILLATOR

The WDT derives its time base from the 31 kHz LFINTOSC. The LTS bit of the OSCCON register does not reflect that the LFINTOSC is enabled.

The value of WDTCON is '- - - 0 1000' on all Resets. This gives a nominal time base of 17 ms.

Note: When the Oscillator Start-up Timer (OST) is invoked, the WDT is held in Reset, because the WDT Ripple Counter is used by the OST to perform the oscillator delay count. When the OST count has expired, the WDT will begin counting (if enabled).

14.5.2 WDT CONTROL

The WDTE bit is located in the Configuration Word register. When set, the WDT runs continuously.

When the WDTE bit in the Configuration Word register is set, the SWDTEN bit of the WDTCON register has no effect. If WDTE is clear, then the SWDTEN bit can be used to enable and disable the WDT. Setting the bit will enable it and clearing the bit will disable it.

The PSA and PS<2:0> bits of the OPTION register have the same function as in previous versions of the PIC16F631/677/685/687/689/690 Family of microcontrollers. See **Section 5.0 "Timer0 Module"** for more information.

FIGURE 14-9: WATCHDOG TIMER BLOCK DIAGRAM

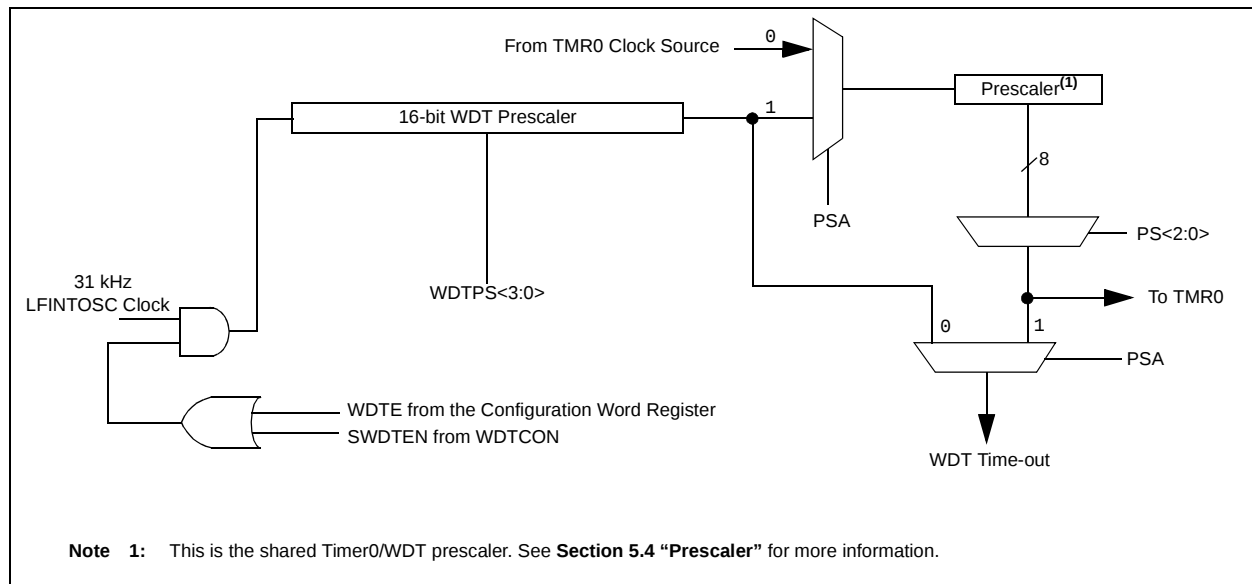
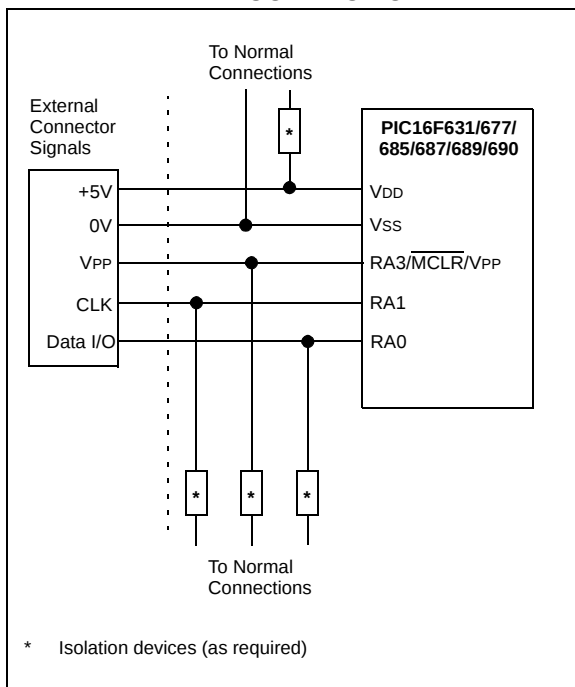


TABLE 14-7: WDT STATUS

Conditions	WDT
WDTE = 0	Cleared
CLRWDT Command	
Oscillator Fail Detected	
Exit Sleep + System Clock = T1OSC, EXTRC, INTOSC, EXTCLK	
Exit Sleep + System Clock = XT, HS, LP	Cleared until the end of OST

FIGURE 14-11: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION



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MOVF	Move f
Syntax:	[<i>label</i>] MOVF f,d
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$
Operation:	$(f) \rightarrow (\text{dest})$
Status Affected:	Z
Description:	The contents of register 'f' is moved to a destination dependent upon the status of 'd'. If $d = 0$, destination is W register. If $d = 1$, the destination is file register 'f' itself. $d = 1$ is useful to test a file register since status flag Z is affected.
Words:	1
Cycles:	1
Example:	MOVF FSR, 0 After Instruction W = value in FSR register Z = 1

MOVLW	Move literal to W
Syntax:	[<i>label</i>] MOVLW k
Operands:	$0 \leq k \leq 255$
Operation:	$k \rightarrow (W)$
Status Affected:	None
Description:	The 8-bit literal 'k' is loaded into W register. The "don't cares" will assemble as '0's.
Words:	1
Cycles:	1
Example:	MOVLW 0x5A After Instruction W = 0x5A

MOVWF	Move W to f
Syntax:	[<i>label</i>] MOVWF f
Operands:	$0 \leq f \leq 127$
Operation:	$(W) \rightarrow (f)$
Status Affected:	None
Description:	Move data from W register to register 'f'.
Words:	1
Cycles:	1
Example:	MOVW OPTION F Before Instruction OPTION = 0xFF W = 0x4F After Instruction OPTION = 0x4F W = 0x4F

NOP	No Operation
Syntax:	[<i>label</i>] NOP
Operands:	None
Operation:	No operation
Status Affected:	None
Description:	No operation.
Words:	1
Cycles:	1
Example:	NOP

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17.5 Thermal Considerations

Standard Operating Conditions (unless otherwise stated)					
Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$					
Param No.	Sym.	Characteristic	Typ.	Units	Conditions
TH01	θ_{JA}	Thermal Resistance Junction to Ambient	62.4	C/W	20-pin PDIP package
			85.2	C/W	20-pin SOIC package
			108.1	C/W	20-pin SSOP package
			40	C/W	20-pin QFN 4x4mm package
TH02	θ_{JC}	Thermal Resistance Junction to Case	28.1	C/W	20-pin PDIP package
			24.2	C/W	20-pin SOIC package
			32.2	C/W	20-pin SSOP package
			2.5	C/W	20-pin QFN 4x4mm package
TH03	T_{DIE}	Die Temperature	150	C	For derated power calculations
TH04	PD	Power Dissipation	—	W	$PD = P_{INTERNAL} + P_{I/O}$
TH05	$P_{INTERNAL}$	Internal Power Dissipation	—	W	$P_{INTERNAL} = I_{DD} \times V_{DD}$ (Note 1)
TH06	$P_{I/O}$	I/O Power Dissipation	—	W	$P_{I/O} = \sum (I_{OL} \times V_{OL}) + \sum (I_{OH} \times (V_{DD} - V_{OH}))$
TH07	P_{DER}	Derated Power	—	W	$P_{DER} = P_{D_{MAX}} (T_{DIE} - T_A) / \theta_{JA}$ (Note 2, 3)

Note 1: I_{DD} is current to run the chip alone without driving any load on the output pins.

2: T_A = Ambient Temperature.

3: Maximum allowable power dissipation is the lower value of either the absolute maximum total power dissipation or derated power.

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FIGURE 18-10: I_{DD} vs. V_{DD} OVER F_{osc} (LFINTOSC MODE, 31 kHz)

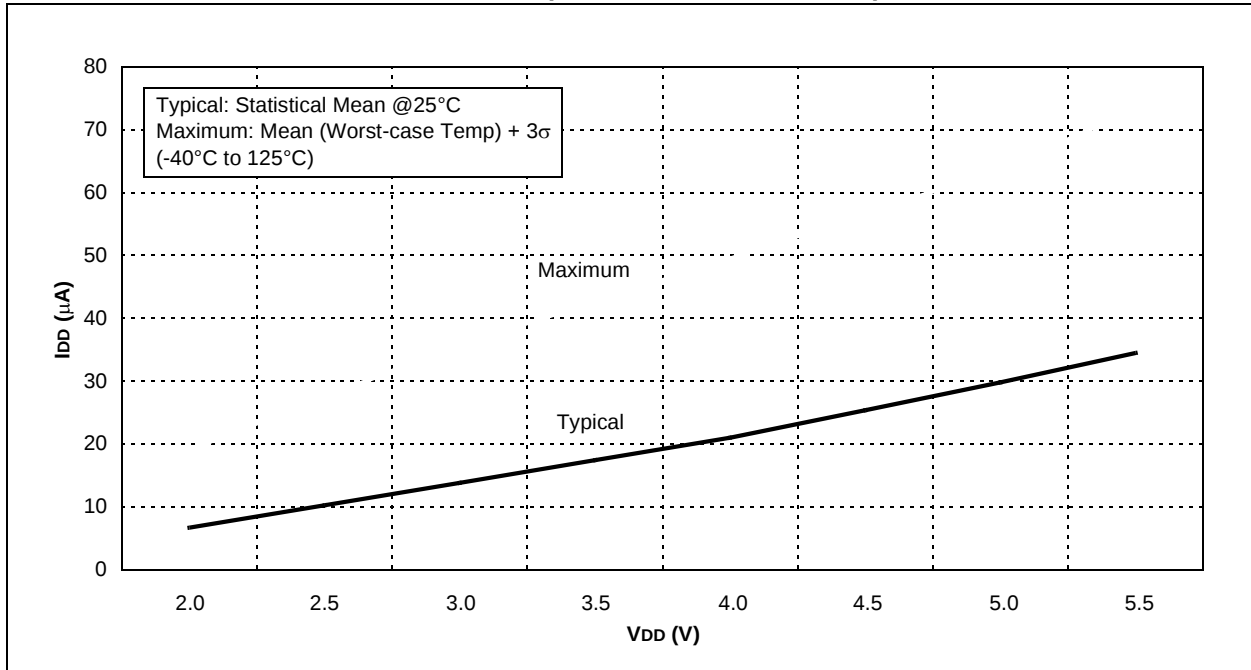
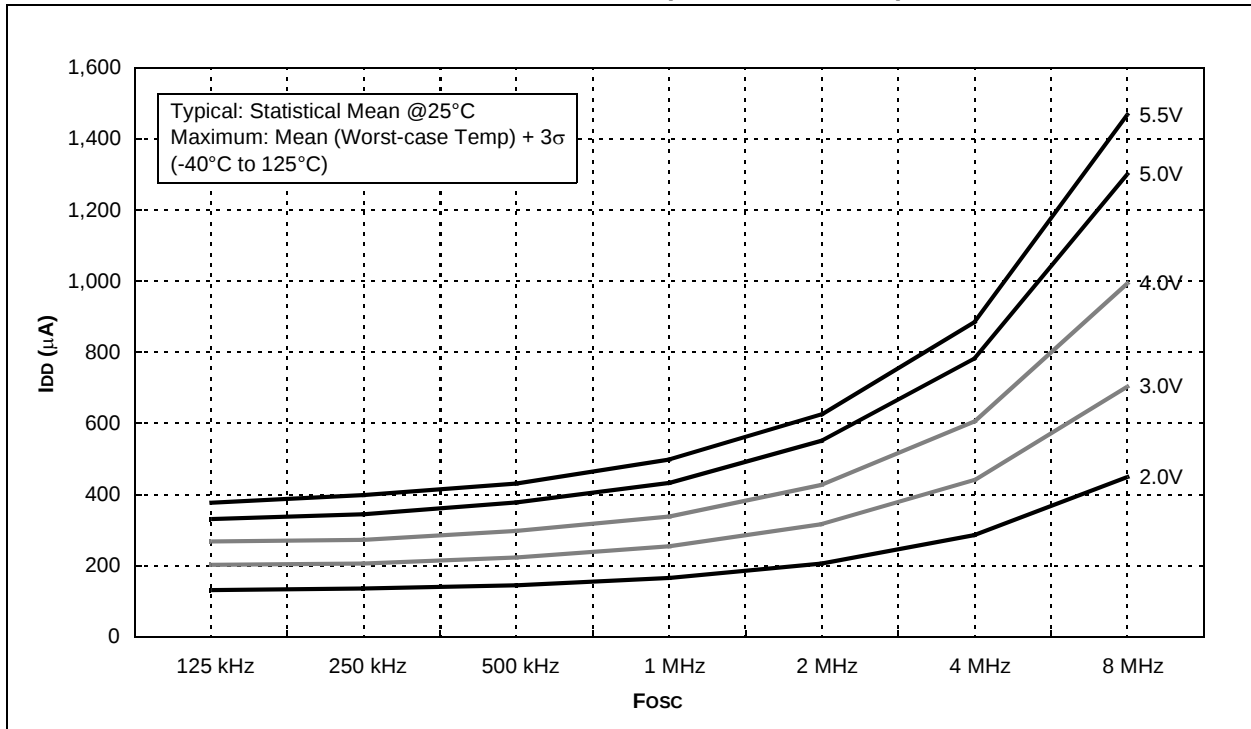


FIGURE 18-11: TYPICAL I_{DD} vs. F_{osc} OVER V_{DD} (HFINTOSC MODE)



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FIGURE 18-34: LFINTOSC FREQUENCY vs. V_{DD} OVER TEMPERATURE (31 kHz)

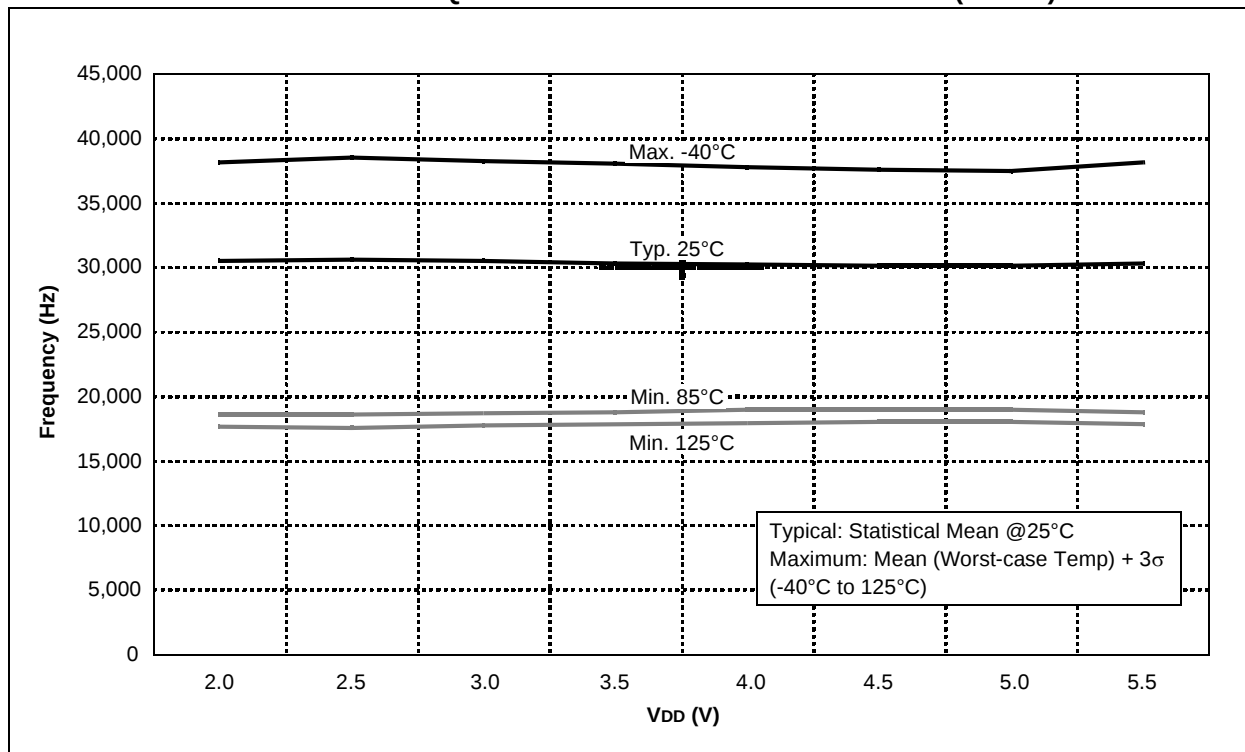


FIGURE 18-35: ADC CLOCK PERIOD vs. V_{DD} OVER TEMPERATURE

